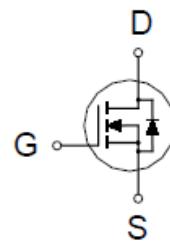
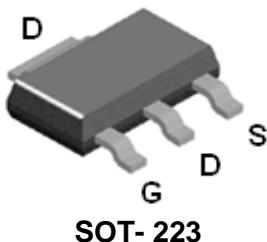


PA110BLA

N-Channel Enhancement Mode MOSFET

PRODUCT SUMMARY

| $V_{(BR)DSS}$ | $R_{DS(ON)}$ | I_D |
|---------------|------------------------|-------|
| 100V | 110mΩ @ $V_{GS} = 10V$ | 3A |



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ C$ Unless Otherwise Noted)

| PARAMETERS/TEST CONDITIONS | SYMBOL | LIMITS | UNITS |
|------------------------------------------------|----------------|------------|-------|
| Gate-Source Voltage | V_{GS} | ± 20 | V |
| Continuous Drain Current | I_D | 6 | A |
| | | 3.2 | |
| | | 2 | |
| Pulsed Drain Current ¹ | I_{DM} | 15 | |
| Avalanche Current | I_{AS} | 6.6 | |
| Avalanche Energy | E_{AS} | 2.2 | mJ |
| Power Dissipation | P_D | 2.5 | W |
| | | 1 | |
| Operating Junction & Storage Temperature Range | T_J, T_{STG} | -55 to 150 | °C |

THERMAL RESISTANCE RATINGS

| THERMAL RESISTANCE | SYMBOL | TYPICAL | MAXIMUM | UNITS |
|----------------------------------|-----------------|---------|---------|--------|
| Junction-to-Ambient ² | $R_{\theta JA}$ | | 50 | °C / W |
| Junction-to-Case | $R_{\theta JC}$ | | 14 | |

¹Pulse width limited by maximum junction temperature.

²The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^\circ C$.

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ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$, Unless Otherwise Noted)

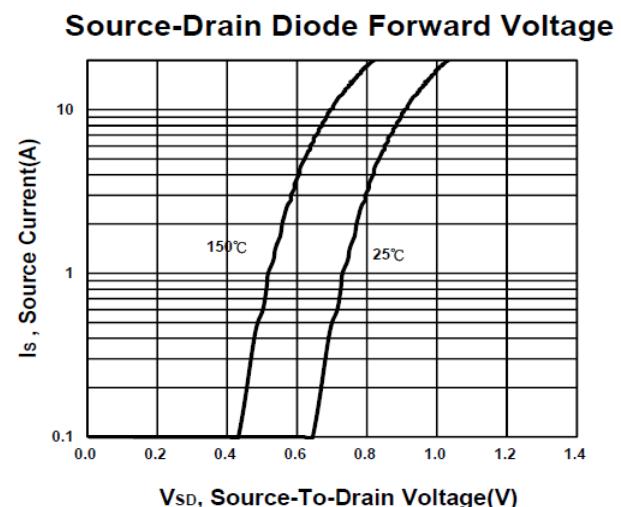
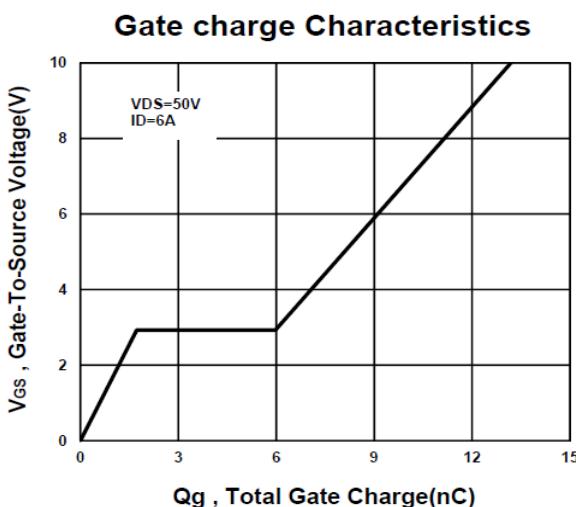
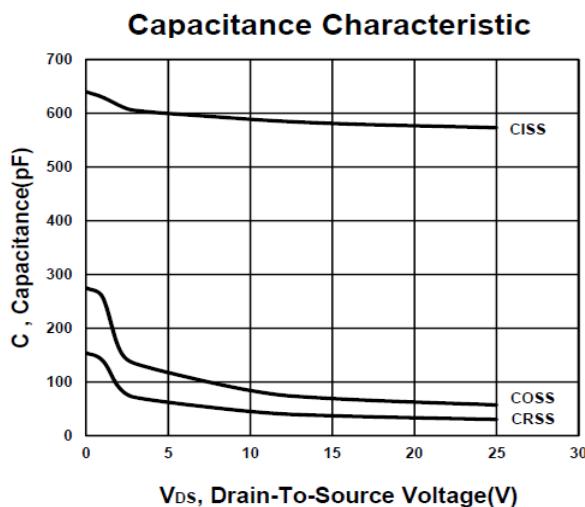
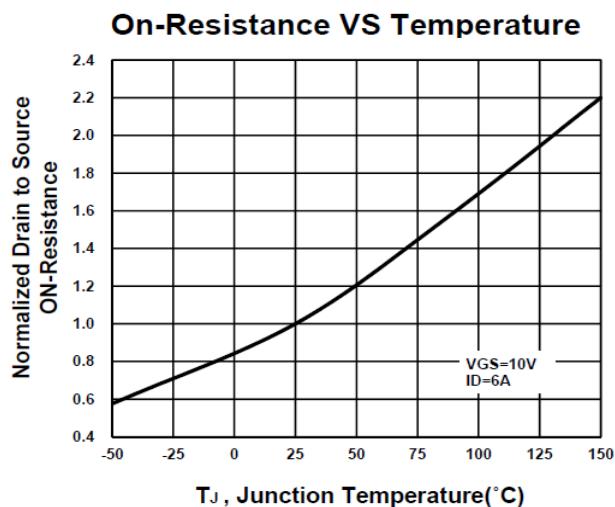
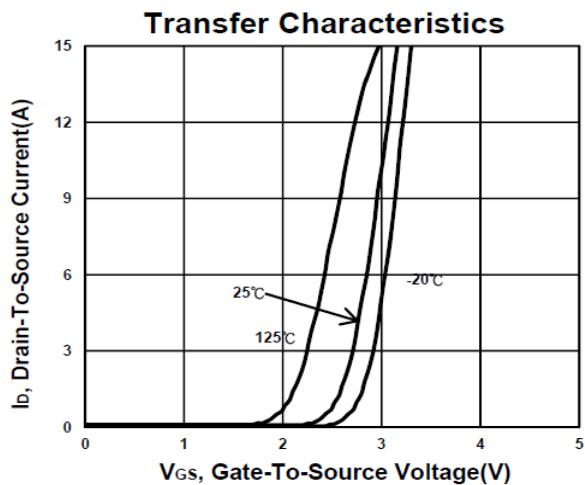
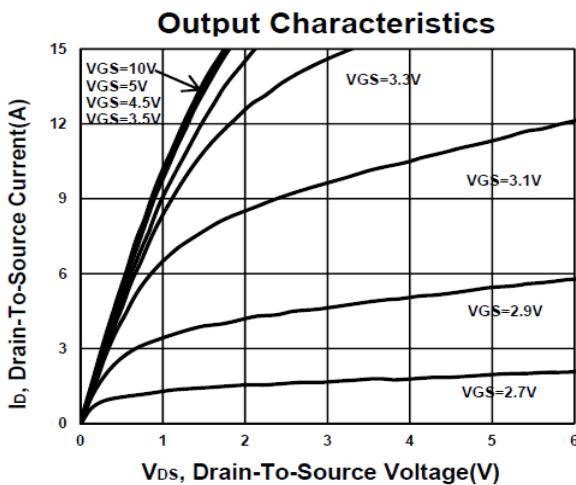
| PARAMETER | SYMBOL | TEST CONDITIONS | LIMITS | | | UNITS |
|---------------------------------------------------------------------------------------------|-----------------------------|--------------------------------------------------------------------------------------------------------------|--------|-----|-----------|------------------|
| | | | MIN | TYP | MAX | |
| STATIC | | | | | | |
| Drain-Source Breakdown Voltage | $V_{(\text{BR})\text{DSS}}$ | $V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$ | 100 | | | V |
| Gate Threshold Voltage | $V_{\text{GS}(\text{th})}$ | $V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$ | 1 | 1.8 | 3 | |
| Gate-Body Leakage | I_{GSS} | $V_{\text{DS}} = 0\text{V}, V_{\text{GS}} = \pm 20\text{V}$ | | | ± 100 | nA |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{\text{DS}} = 80\text{V}, V_{\text{GS}} = 0\text{V}$ | | | 1 | μA |
| | | $V_{\text{DS}} = 80\text{V}, V_{\text{GS}} = 0\text{V}, T_J = 125^\circ\text{C}$ | | | 10 | |
| Drain-Source On-State Resistance ¹ | $R_{\text{DS}(\text{ON})}$ | $V_{\text{GS}} = 4.5\text{V}, I_D = 6\text{A}$ | | 89 | 120 | $\text{m}\Omega$ |
| | | $V_{\text{GS}} = 10\text{V}, I_D = 6\text{A}$ | | 84 | 110 | |
| Forward Transconductance ¹ | g_{fs} | $V_{\text{DS}} = 5\text{V}, I_D = 6\text{A}$ | | 22 | | S |
| DYNAMIC | | | | | | |
| Input Capacitance | C_{iss} | $V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 25\text{V}, f = 1\text{MHz}$ | | 579 | | pF |
| Output Capacitance | C_{oss} | | | 57 | | |
| Reverse Transfer Capacitance | C_{rss} | | | 31 | | |
| Gate Resistance | R_g | $V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 0\text{V}, f = 1\text{MHz}$ | | 1.4 | | Ω |
| Total Gate Charge ² | Q_g | $V_{\text{DS}} = 50\text{V}, V_{\text{GS}} = 10\text{V}, I_D = 6\text{A}$ | | 14 | | nC |
| Gate-Source Charge ² | Q_{gs} | | | 1.8 | | |
| Gate-Drain Charge ² | Q_{gd} | | | 4.6 | | |
| Turn-On Delay Time ² | $t_{\text{d}(\text{on})}$ | $V_{\text{DS}} = 50\text{V}, I_D \approx 6\text{A}$ $V_{\text{GS}} = 10\text{V}, R_{\text{GS}} = 6\Omega$ | | 16 | | nS |
| Rise Time ² | t_r | | | 5 | | |
| Turn-Off Delay Time ² | $t_{\text{d}(\text{off})}$ | | | 36 | | |
| Fall Time ² | t_f | | | 10 | | |
| SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_J = 25^\circ\text{C}$) | | | | | | |
| Continuous Current | I_S | | | | 1.7 | A |
| Forward Voltage ¹ | V_{SD} | $I_F = 6\text{A}, V_{\text{GS}} = 0\text{V}$ | | | 1.4 | V |
| Reverse Recovery Time | t_{rr} | $I_F = 6\text{A}, dI/dt = 100\text{A} / \mu\text{s}$ | | 22 | | nS |
| Reverse Recovery Charge | Q_{rr} | | | 15 | | nC |

¹Pulse test : Pulse Width $\leq 300\ \mu\text{sec}$, Duty Cycle $\leq 2\%$.

²Independent of operating temperature.

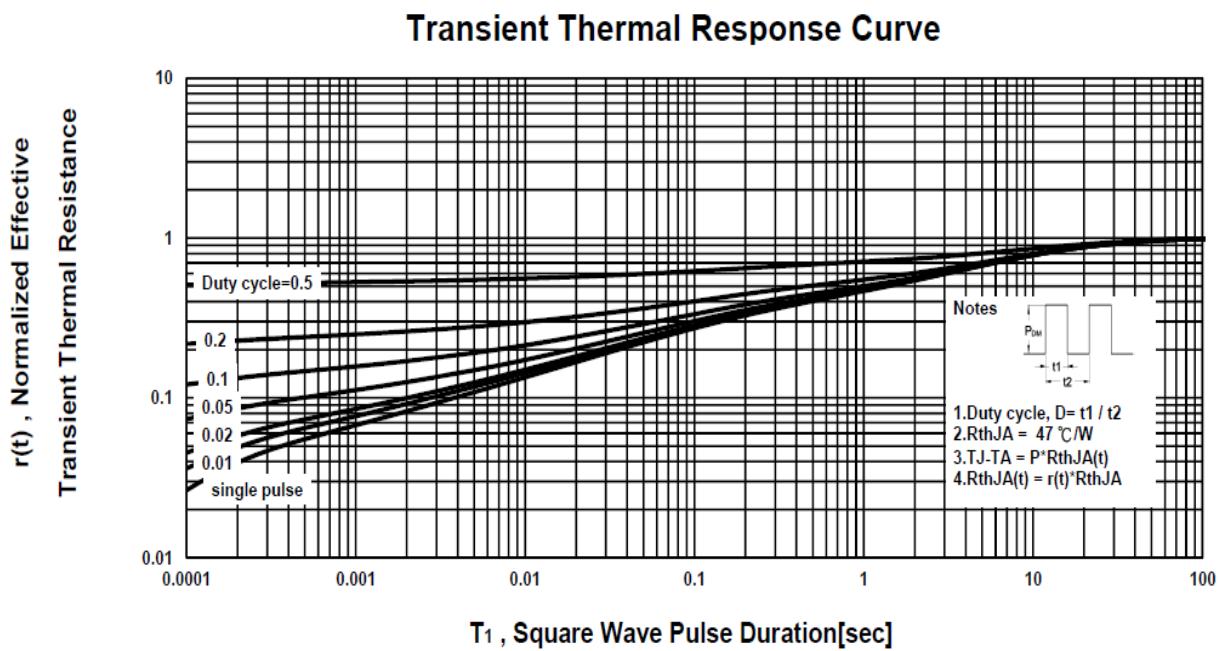
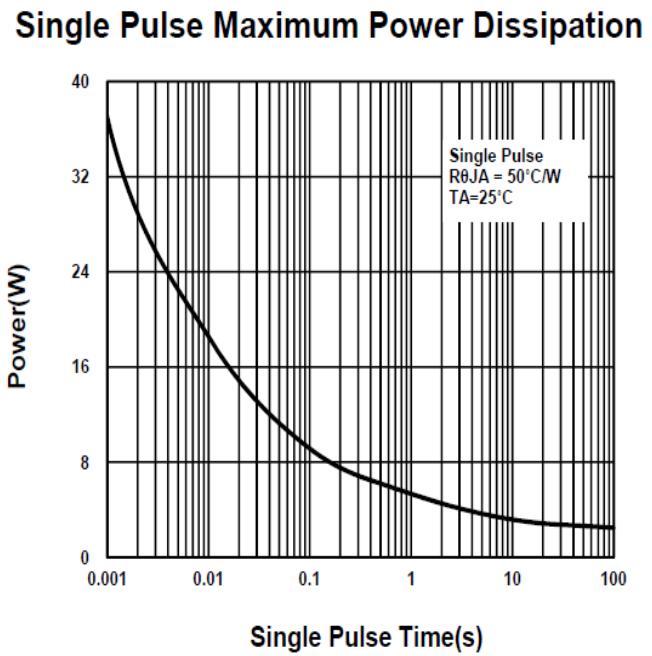
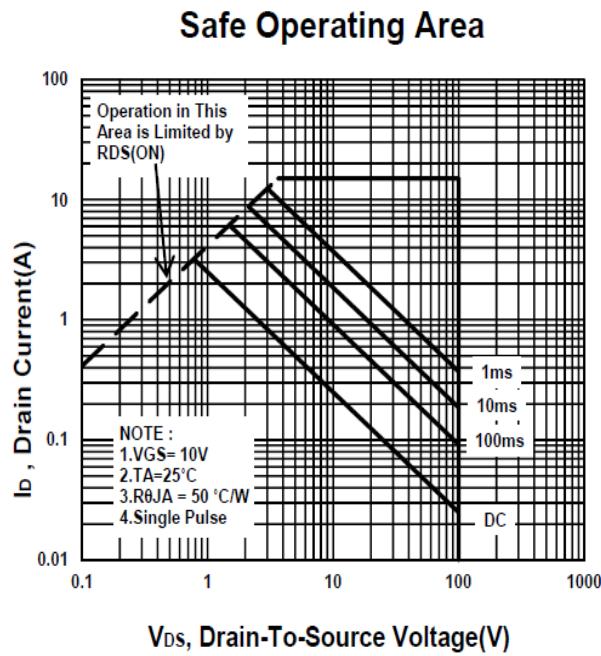
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N-Channel Enhancement Mode MOSFET



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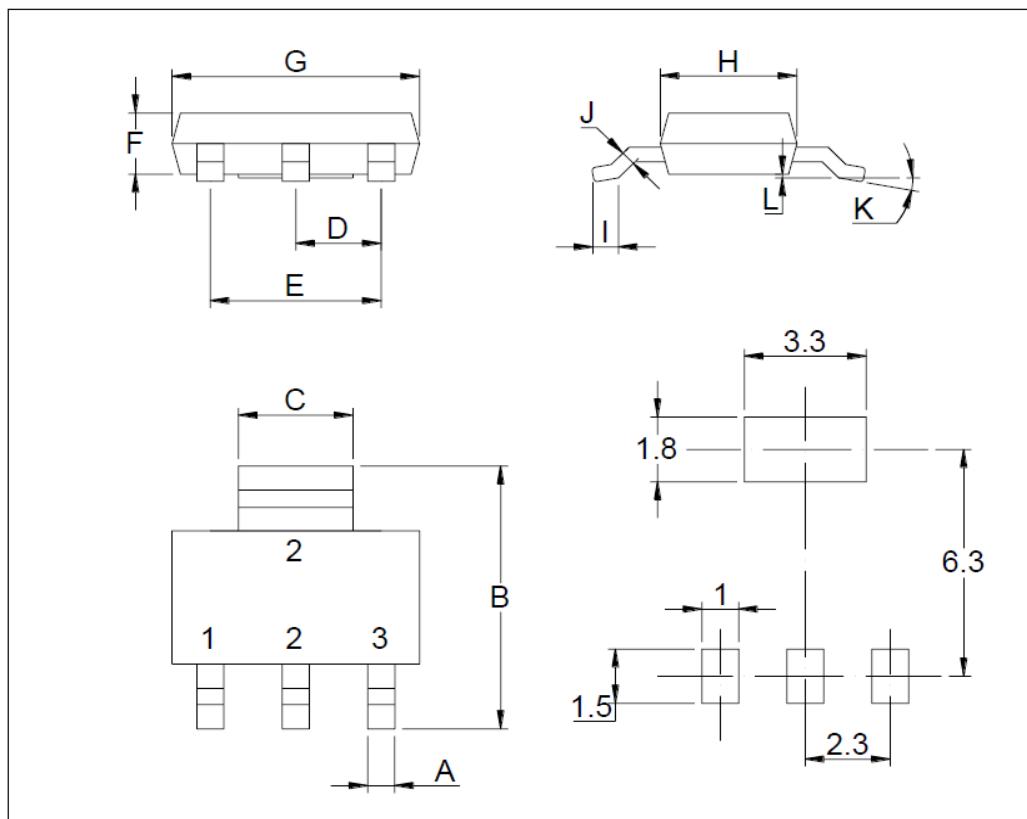


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SOT-223 MECHANICAL DATA

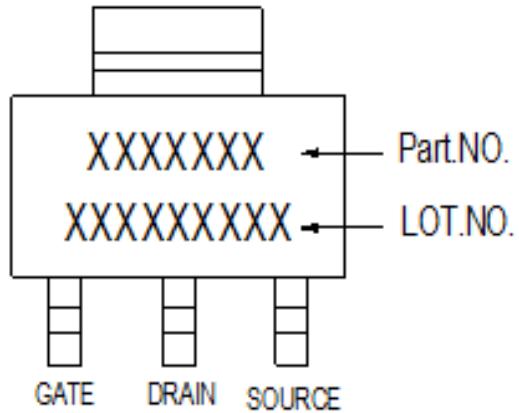
| Dimension | mm | | | Dimension | mm | | |
|-----------|------|------|------|-----------|------|------|------|
| | Min. | Typ. | Max. | | Min. | Typ. | Max. |
| A | 0.60 | 0.76 | 0.84 | H | 3.30 | 3.50 | 3.70 |
| B | 6.70 | 7.00 | 7.30 | I | 0.50 | 1.00 | 1.20 |
| C | 2.85 | 3.00 | 3.10 | J | 0.23 | 0.3 | 0.4 |
| D | 2.25 | 2.30 | 2.35 | K | 0° | | 10° |
| E | 4.35 | 4.60 | 4.85 | L | 0 | 0.1 | 0.2 |
| F | 1.40 | 1.60 | 1.80 | M | | | |
| G | 6.30 | 6.50 | 6.80 | N | | | |



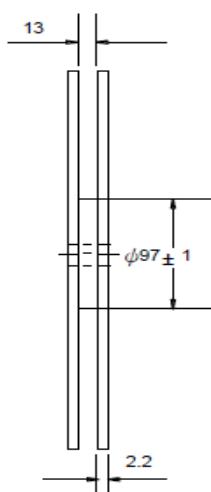
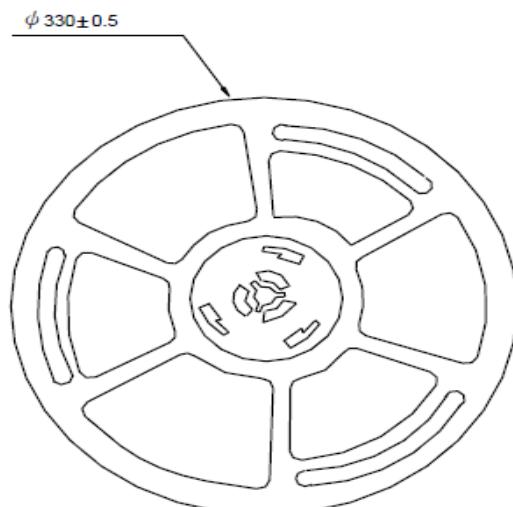
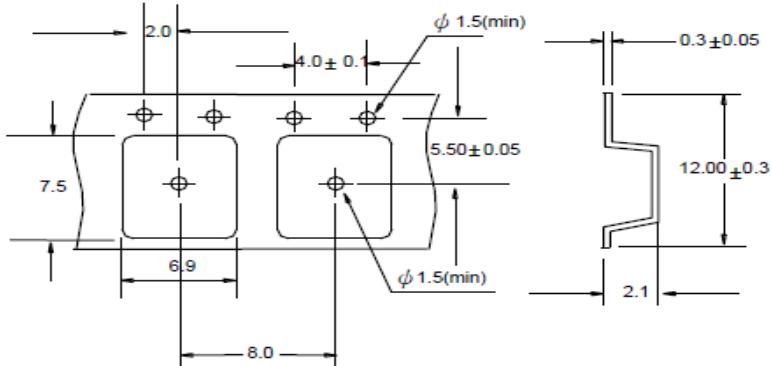
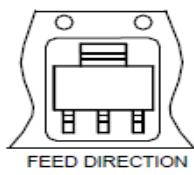
PA110BLA

N-Channel Enhancement Mode MOSFET

A. Marking Information



B. Tape&Reel Information: 2500pcs/Reel



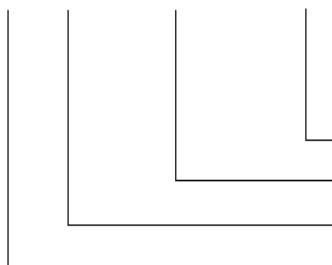
PA110BLA

N-Channel Enhancement Mode MOSFET

C. Lot.No. & Date Code rule

1.LOT.NO.

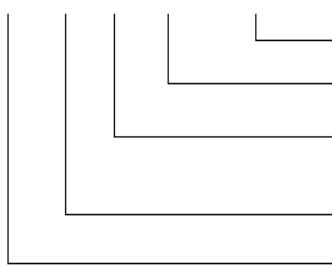
M N 15M21 03



- #8~9 Sub-lot No
- Order series no.
- Foundry site
- Assembly site

2.Date Code

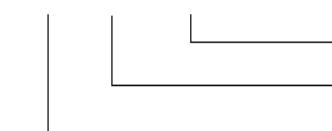
D Y M X XXX



- Order series no. & Sub-lot No
- Week
- M : Month (A:Jan , B:Feb , C:Mar ,D :Apr ,E:May ,F:Jun,G:Jul,H:Aug,I:Sep,J:Oct,K:Nov,L:Dec.)
- Y : Year (N : 2011, O : 2012 ...)
- Assembly site

3.Date Code (for Small package)

XX Y WW



- Week
- Y : Year (9: 2009,A : 2010, B : 2011 ...)
- Device Name

PA110BLA**N-Channel Enhancement Mode MOSFET****D.Label rule**

标签内容(Label content)



| | | |
|----|--------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1 | Label Size | 30 * 90 mm |
| 2 | Font style | Times New Roman or Arial (或可区分英文“0”和数字“0”，“G”和“Q”的字型即可) |
| 3 | Great Power | Height: 4 mm |
| 4 | Package | Height: 2 mm |
| 5 | Date | Height: 2 mm Shipping date: YYYY/MM/DD, ex. 2008/09/12 |
| 6 | Device | Height: 3 mm (Max: 16 Digit) |
| 7 | Lot | Height: 3 mm (Max: 9 Digit) Sub lot |
| 8 | D/C | Height: 3 mm (Max: 7 Digit) |
| 9 | QTY | Height: 3 mm (Max: 6 Digit) Thousand mark is no needed |
| 10 | Pb Free label |  Diameter: 1 cm bottom color: Green Font color: Black Font style: Arial |
| 11 | Halogen Free label |  Diameter: 1 cm bottom color: Green Font color: Black Font style: Arial |
| 12 | Scan info | Device / Lot / D/C / QTY , Insert “ / “ between every parts. for example: P3055LDG/G12345601/GGG2301/2000 DPI (Dots per inch): Over 300 dpi Code : Code 128 Height: 6 mm at least |